Electronic Materials and Processes for Space (EMPS) Workshop

Tuesday, 1 June 2021

Session 2: Emerging technologies - Virtual (11:25 - 12:40)

-Conveners: Jussi Hokka

time	[id] title	presenter
11:25	[8] Overview of R&D activites and ESA harmonisation roadmap	HOKKA, Jussi HELTZEL, Stan
11:50	[9] ALD coatings to mitigate tin whiskers and for upgrade of environmental durability of electronic assemblies	PUDAS, Marko
12:15	[10] COTS and lead-free electronic assemblies	COROCHER, Gianni

Session 2: Emerging technologies - Virtual (13:40 - 14:30)

time	[id] title	presenter
13:40	[11] Robotic and low temperature soldering	WILLIS, Bob
14:05	[12] Characterisation of 3D MID for space telecom applications (3D-MID4SPACE)	RUZICKA, Klaus